

Supplementary information for

Multi-elemental analysis of solder using ETV-ICPOES for applications in forensic science

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|------|------|------|------|-------|-------|-------|---------|
| 5 cm | 5 cm | 5 cm | 5 cm | 45 cm | 45 cm | 45 cm | 23.5 cm |
| S1 | S2 | S3 | S4 | S5 | S6 | S7 | S8 |

| | | | | | | |
|-------|-------|-------|-------|-------|-------|-------|
| 45 cm | 45 cm | 45 cm | 45 cm | 45 cm | 45 cm | 45 cm |
| B1 | B2 | B3 | B4 | B5 | B6 | B7 |

Fig. S1 Sub-sampling of solder wires. EDM-3 (top) spans a total of 178.5 cm; ON-003 (bottom) spans a total of 315 cm.